

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.



1N5820 - 1N5822

1N5820-1N5822

Features

- 3.0 ampere operation at $T_A = 95^\circ\text{C}$ with no thermal runaway.
- For use in low voltage, high frequency inverters free wheeling, and polarity protection applications.



DO-201AD

COLOR BAND DENOTES CATHODE

Schottky Rectifiers

Absolute Maximum Ratings*

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value			Units
		1N5820	1N5821	1N5822	
V_{RRM}	Maximum Repetitive Reverse Voltage	20	30	40	V
$I_{F(AV)}$	Average Rectified Forward Current 3/8 " lead length @ $T_A = 95^\circ\text{C}$	3.0			A
I_{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	80			A
T_{stg}	Storage Temperature Range	-65 to +125			$^\circ\text{C}$
T_J	Operating Junction Temperature	-65 to +125			$^\circ\text{C}$

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	3.6	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	28	$^\circ\text{C/W}$

Electrical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Device			Units
		1N5820	1N5821	1N5822	
V_F	Forward Voltage @ 3.0 A	475	500	525	mV
	@ 9.4 A	850	900	950	mV
I_R	Reverse Current @ rated V_R	0.5			mA
	$T_A = 25^\circ\text{C}$	20			mA
	$T_A = 100^\circ\text{C}$				
C_T	Total Capacitance $V_R = 4.0\text{ V}$, $f = 1.0\text{ MHz}$	190			pF

Typical Characteristics

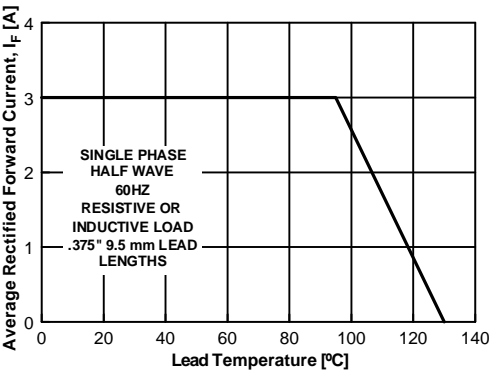


Figure 1. Forward Current Derating Curve

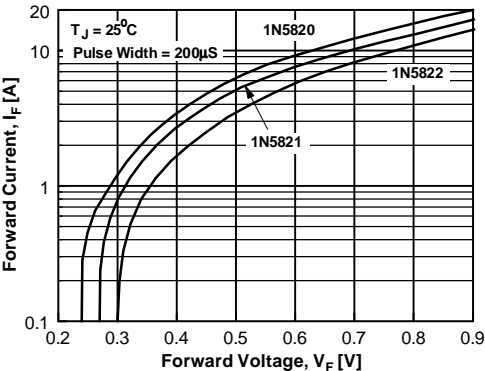


Figure 2. Forward Voltage Characteristics

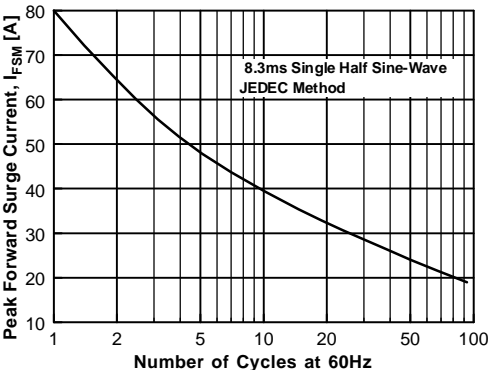


Figure 3. Non-Repetitive Surge Current

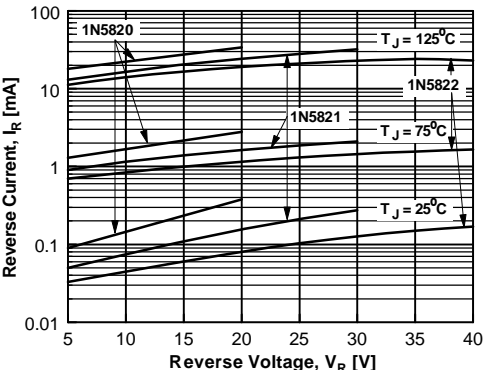


Figure 4. Reverse Current vs Reverse Voltage

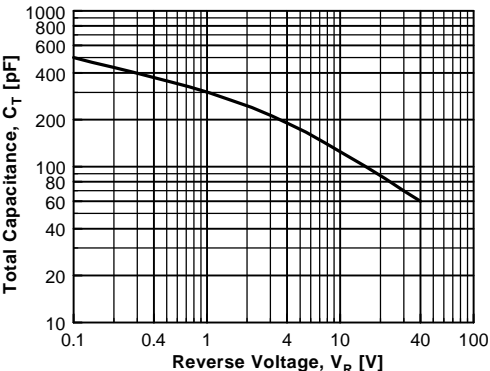


Figure 5. Total Capacitance

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DenseTrench™	GTO™	Power247™	SuperSOT™-6	
DOMETM	HiSeC™	PowerTrench®	SuperSOT™-8	
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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.